

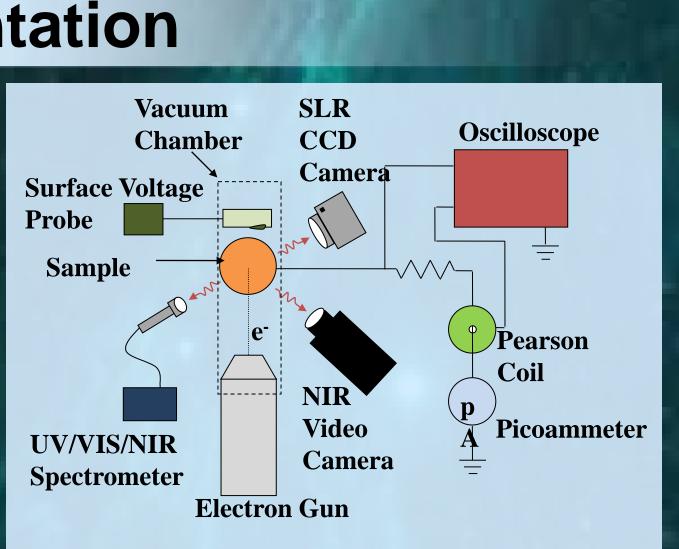
Abstract

Measurements of the charge distribution in electron-bombarded, thin-film, multilayered dielectric samples showed that charging of multilayered materials evolves with time and is highly dependent on incident energy; this is driven by electron penetration depth, electron emission and material conductivity. Based on the net surface potential's dependence on beam current, electron range, electron emission and conductivity, measurements of the surface potential, displacement current and beam energy allow the charge distribution to be inferred. To take these measurements, a thin-film disordered SiO₂ structure with a conductive middle layer was charged using 200 eV and 5 keV electron beams with regular 15 s pulses at 1 nA/cm² to 500 nA/cm². Results show that there are two basic charging scenarios which are consistent with simple charging models; these are analyzed using independent determinations of the material's electron range, yields, and conductivity. Large negative net surface potentials led to electrostatic breakdown and large visible arcs, which have been observed to lead to detrimental spacecraft charging effects.

Experimentation

In order to investigate the charging of multilayered dielectric materials, pulsed charging experiments were conducted using multilayered dielectric materials of an SiO₂ based optical coating, a conductive middle layer and Probe an SiO₂ substrate. Tests were made with the conductive layer both grounded and ungrounded. Experiments were conducted in the main USU electron emission ultrahigh vacuum test chamber, modified for observations of low intensity UV/VIS/NIR glow over a broad range of sample temperatures. Figure 1 provides a general schematic of the experimental system used.

The samples were subjected to short pulses ($t_{on} \approx 15$ s) of electron bombardment using a monoenergetic electron beam with beam energies of either 200 eV or 5 keV. A low energy electron gun [Staib, EK-5-S1] was used, that can deliver a well-characterized, low-flux pulsed beam (typically ~50pA/cm² to 1 μ A/cm²) over an energy range of Fig. 1. 20 eV to 5 keV. The defocused electron beam produced a beam profile at the sample with about ±30% uniformity over an ~3 cm diameter beam spot. Beam fluxes were monitored with a Faraday cup. Beam current densities of 20±1 nA/cm² at 200 eV and 2.7±1 nA/cm² at 5 keV were used for the experiments reported here, with an exposed sample area of 4.9±0.2 cm².



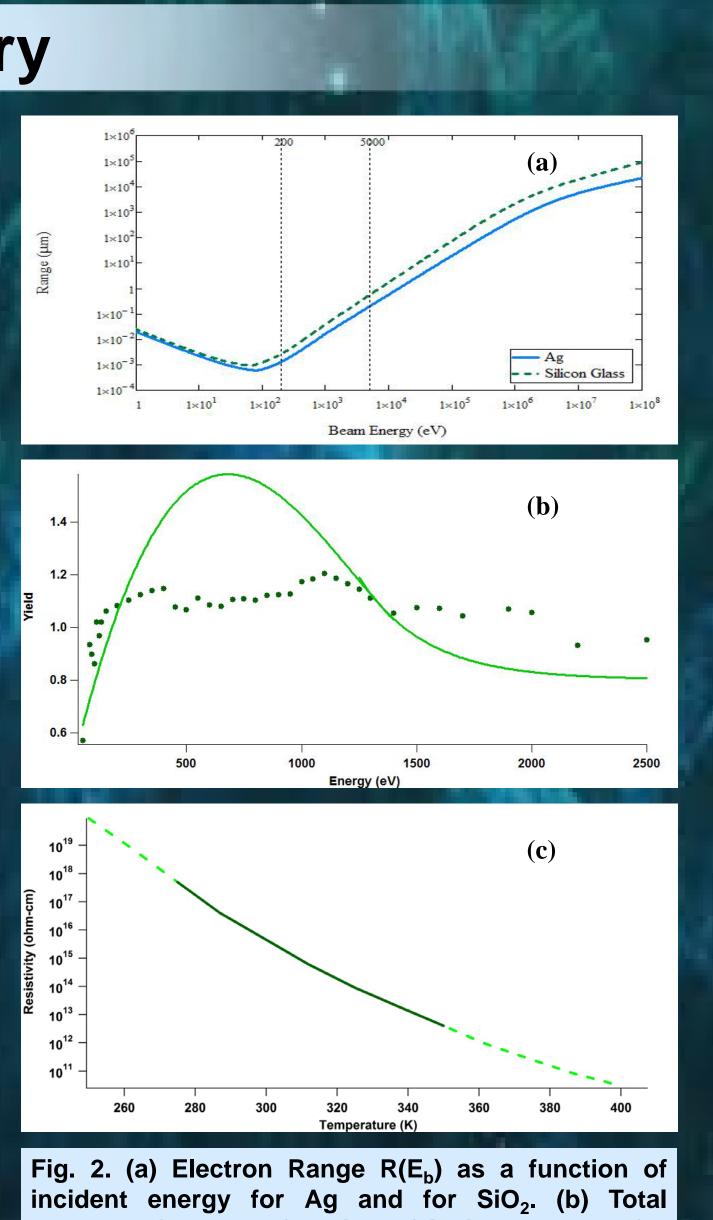
Block diagram of instrumentation for collecting the pulse charging surface voltage and electrode current data induced by electron beam bombardment includes Instrumentation picoammeters, Pearson coils, and a storage oscilloscope for electrode current measurements and UV/VIS and IR spectrometers, an SLR CCD still camera, and a NIR video camera for optical measurements.

Four experiments are considered as depicted in Fig. 6. The experiments differ in terms of the incident energy and flux, and as we will see below, produce dramatically different results. To interpret the experiments, we must consider three physical phenomena—the electron range, electron yield and the electron transport (conductivity) of the material—and how they are affected by the experimental conditions. <u>Range</u>

The electron range is the maximum distance an electron of a given incident energy can penetrate through a material at a given incident energy, E_{b} , as the incident electron undergoes a succession of energy loss collisions and ultimately deposits charge at $R(E_{h})$ when all energy is expended (see Fig. 4). Figure 2(a) shows the results of a composite model for the energy dependence of the range spanning from a few eV to 10⁷ eV. Knowing the range of electrons becomes especially critical when dealing with multilayered materials, where the incident energy will determine where and in what layer charge and energy are deposited. The low (200 eV) and high (5 keV) incident energies were selected for these experiments based on range calculations to deposit charge at the mid-point between the surface dielectric and the conductor and into the conductive layer, respectively **Electron Yield**

The total electron yield is defined as the ratio of emitted to incident flux and is highly energy dependent. The incident flux is the total number of electrons entering the material from the environment; the emitted flux is the sum of backscattered and secondary electrons, as shown in Fig. 4. Secondary electrons generally have energies <50 eV, while backscattered electrons generally have energies >50 eV.

Theory



Electron yield as a function of incident energy for SiO₂. (c) Resistivity as a function of temperature for SiO_o

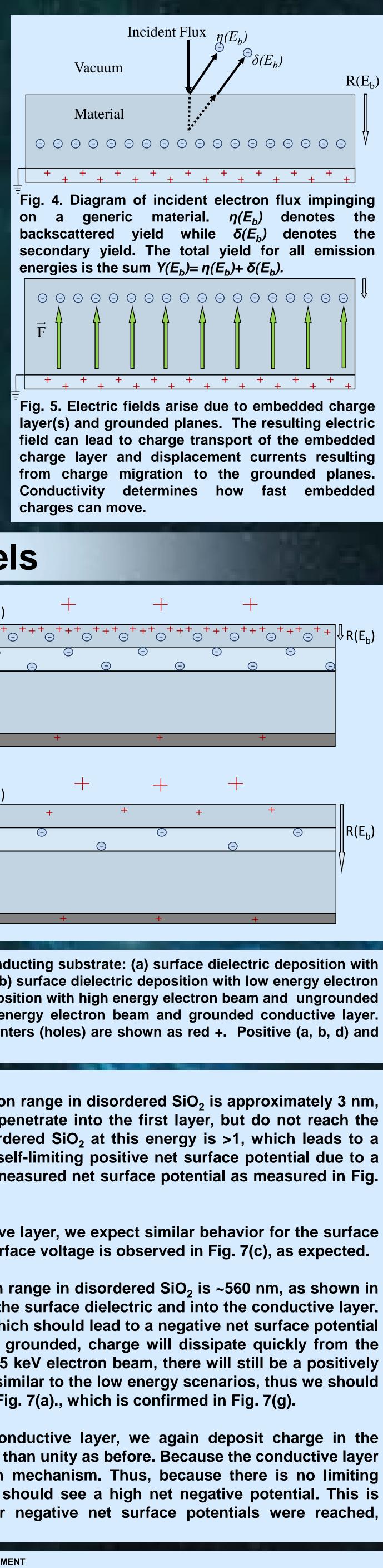
Electron Induced Charging and Arcing of Multilayered Dielectric Materials

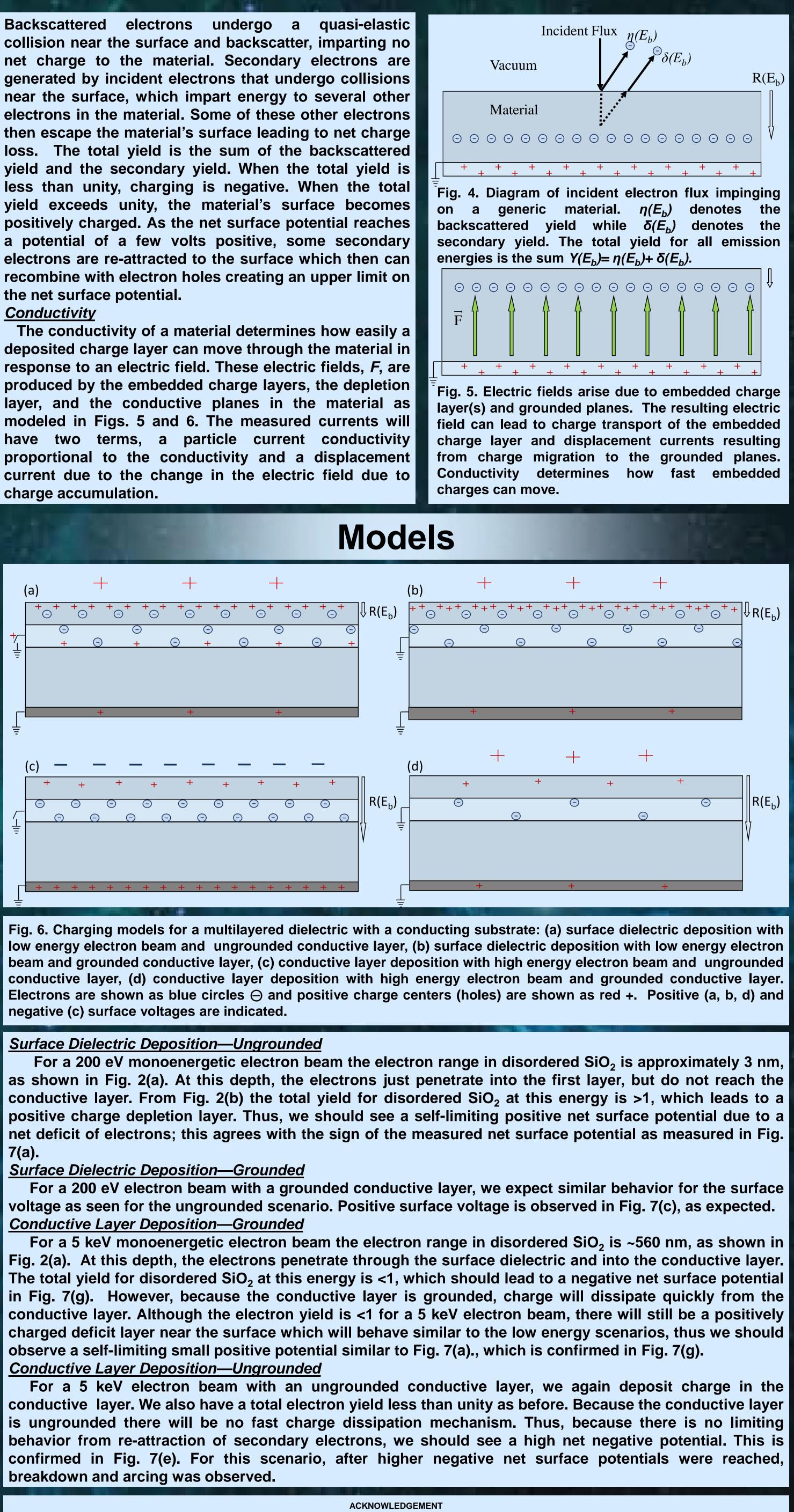
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Backscattered electrons undergo a quasi-elastic collision near the surface and backscatter, imparting no net charge to the material. Secondary electrons are generated by incident electrons that undergo collisions near the surface, which impart energy to several other electrons in the material. Some of these other electrons then escape the material's surface leading to net charge loss. The total yield is the sum of the backscattered yield and the secondary yield. When the total yield is less than unity, charging is negative. When the total yield exceeds unity, the material's surface becomes positively charged. As the net surface potential reaches potential of a few volts positive, some secondary electrons are re-attracted to the surface which then can recombine with electron holes creating an upper limit on the net surface potential.

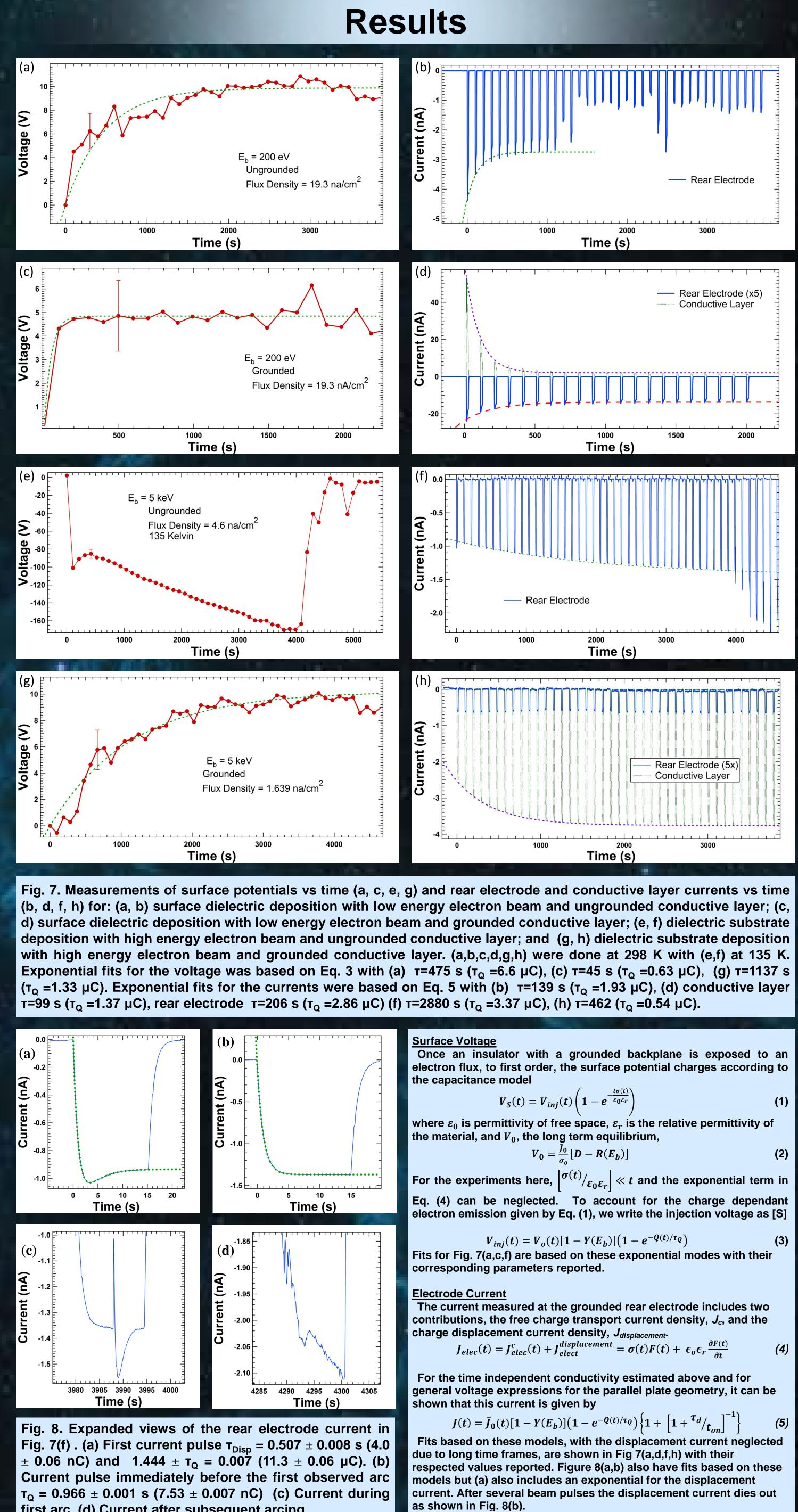
layer, and the conductive planes in the material as proportional to the conductivity and a displacement current due to the change in the electric field due to charge accumulation.





breakdown and arcing was observed.

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first arc. (d) Current after subsequent arcing.

